

SN54HC125, SN74HC125 QUADRUPLE BUS BUFFER GATES WITH 3-STATE OUTPUTS

SCLS104A – MARCH 1984 – REVISED JANUARY 1996

- High-Current 3-State Outputs Interface Directly With System Bus or Can Drive up to 15 LSTTL Loads
- Package Options Include Plastic Small-Outline (D), Shrink Small-Outline (DB), and Ceramic Flat (W) Packages, Ceramic Chip Carriers (FK), and Standard Plastic (N) and Ceramic (J) 300-mil DIPs

description

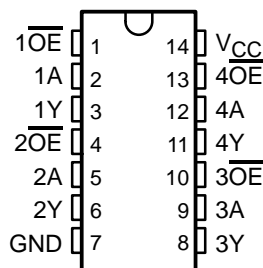
These quadruple bus buffer gates feature independent line drivers with 3-state outputs. Each output is disabled when the associated output-enable (\overline{OE}) input is high.

The SN54HC125 is characterized for operation over the full military temperature range of -55°C to 125°C . The SN74HC125 is characterized for operation from -40°C to 85°C .

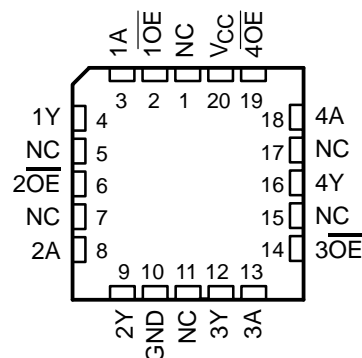
FUNCTION TABLE
(each buffer)

| INPUTS | | OUTPUT Y |
|-----------------|---|-------------|
| \overline{OE} | A | |
| L | H | H |
| L | L | L |
| H | X | Z |

SN54HC125 . . . J OR W PACKAGE
SN74HC125 . . . D, DB, OR N PACKAGE
(TOP VIEW)

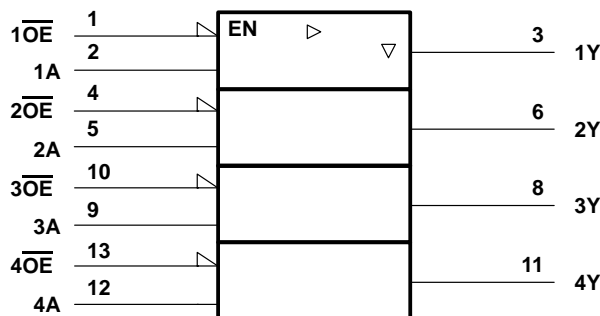


SN54HC125 . . . FK PACKAGE
(TOP VIEW)



NC – No internal connection

logic symbol†



† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12. Pin numbers shown are for the D, DB, J, N, and W packages.



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PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

TEXAS
INSTRUMENTS

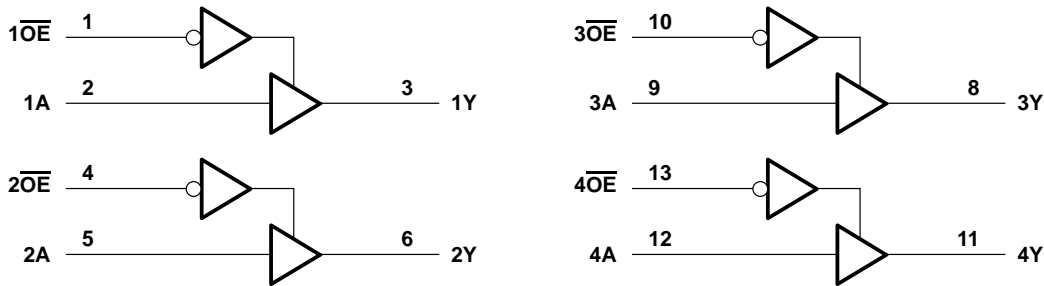
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SN54HC125, SN74HC125
QUADRUPLE BUS BUFFER GATES
WITH 3-STATE OUTPUTS

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logic diagram (positive logic)



Pin numbers shown are for the D, DB, J, N, and W packages.

absolute maximum ratings over operating free-air temperature range†

| | |
|--|----------------|
| Supply voltage range, V_{CC} | –0.5 V to 7 V |
| Input clamp current, I_{IK} ($V_I < 0$ or $V_I > V_{CC}$) (see Note 1) | ± 20 mA |
| Output clamp current, I_{OK} ($V_O < 0$ or $V_O > V_{CC}$) (see Note 1) | ± 20 mA |
| Continuous output current, I_O ($V_O = 0$ to V_{CC}) | ± 35 mA |
| Continuous current through V_{CC} or GND | ± 70 mA |
| Maximum power dissipation at $T_A = 55^\circ\text{C}$ (in still air) (see Note 2): | |
| D package | 1.25 W |
| DB package | 0.5 W |
| N package | 1.1 W |
| Storage temperature range, T_{stg} | –65°C to 150°C |

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.
2. The maximum package power dissipation is calculated using a junction temperature of 150°C and a board trace length of 750 mils, except for the N package, which has a trace length of zero.

recommended operating conditions

| | | | SN54HC125 | | | SN74HC125 | | | UNIT |
|-----------------|---------------------------------------|-------------------------|-----------|-----|-----|-----------------|-----|-----|------|
| | | | MIN | NOM | MAX | MIN | NOM | MAX | |
| V _{CC} | Supply voltage | | 2 | 5 | 6 | 2 | 5 | 6 | V |
| V _{IH} | High-level input voltage | V _{CC} = 2 V | 1.5 | | | 1.5 | | | V |
| | | V _{CC} = 4.5 V | 3.15 | | | 3.15 | | | |
| | | V _{CC} = 6 V | 4.2 | | | 4.2 | | | |
| V _{IL} | Low-level input voltage | V _{CC} = 2 V | 0 | | | 0 | | | V |
| | | V _{CC} = 4.5 V | 0 | | | 1.35 | | | |
| | | V _{CC} = 6 V | 0 | | | 1.8 | | | |
| V _I | Input voltage | | 0 | | | V _{CC} | | | V |
| V _O | Output voltage | | 0 | | | V _{CC} | | | V |
| t _t | Input transition (rise and fall) time | V _{CC} = 2 V | 0 | | | 1000 | | | ns |
| | | V _{CC} = 4.5 V | 0 | | | 500 | | | |
| | | V _{CC} = 6 V | 0 | | | 400 | | | |
| T _A | Operating free-air temperature | | −55 | | | 125 | | | °C |



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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | TEST CONDITIONS | | V _{CC} | T _A = 25°C | | | SN54HC125 | | SN74HC125 | | UNIT |
|-----------------|---|---------------------------|-----------------|-----------------------|-------|------|-----------|-------|-----------|-------|------|
| | | | | MIN | TYP | MAX | MIN | MAX | MIN | MAX | |
| V _{OH} | V _I = V _{IH} or V _{IL} | I _{OH} = –20 µA | 2 V | 1.9 | 1.998 | | 1.9 | | 1.9 | | V |
| | | | 4.5 V | 4.4 | 4.499 | | 4.4 | | 4.4 | | |
| | | | 6 V | 5.9 | 5.999 | | 5.9 | | 5.9 | | |
| | | I _{OH} = –6 mA | 4.5 V | 3.98 | 4.3 | | 3.7 | | 3.84 | | |
| | | I _{OH} = –7.8 mA | 6 V | 5.48 | 5.8 | | 5.2 | | 5.34 | | |
| V _{OL} | V _I = V _{IH} or V _{IL} | I _{OL} = 20 µA | 2 V | | 0.002 | 0.1 | | 0.1 | | 0.1 | V |
| | | | 4.5 V | | 0.001 | 0.1 | | 0.1 | | 0.1 | |
| | | | 6 V | | 0.001 | 0.1 | | 0.1 | | 0.1 | |
| | | I _{OL} = 6 mA | 4.5 V | | 0.17 | 0.26 | | 0.4 | | 0.33 | |
| | | I _{OL} = 7.8 mA | 6 V | | 0.15 | 0.26 | | 0.4 | | 0.33 | |
| I _I | V _I = V _{CC} or 0 | | 6 V | | ±0.1 | ±100 | | ±1000 | | ±1000 | nA |
| I _{OZ} | V _O = V _{CC} or 0 | | 6 V | | ±0.01 | ±0.5 | | ±10 | | ±5 | µA |
| I _{CC} | V _I = V _{CC} or 0, I _O = 0 | | 6 V | | | 8 | | 160 | | 80 | µA |
| C _i | | | 2 V to 6 V | | 3 | 10 | | 10 | | 10 | pF |

switching characteristics over recommended operating free-air temperature range, C_L = 50 pF (unless otherwise noted) (see Figure 1)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | V _{CC} | T _A = 25°C | | | SN54HC125 | | SN74HC125 | | UNIT |
|------------------|------------------------|-------------|-----------------|-----------------------|-----|-----|-----------|-----|-----------|-----|------|
| | | | | MIN | TYP | MAX | MIN | MAX | MIN | MAX | |
| t _{pd} | A | Y | 2 V | | 48 | 120 | | 150 | | 150 | ns |
| | | | 4.5 V | | 14 | 24 | | 36 | | 30 | |
| | | | 6 V | | 11 | 20 | | 25 | | 26 | |
| t _{en} | $\overline{\text{OE}}$ | Y | 2 V | | 53 | 120 | | 180 | | 150 | ns |
| | | | 4.5 V | | 14 | 24 | | 36 | | 30 | |
| | | | 6 V | | 11 | 20 | | 31 | | 26 | |
| t _{dis} | $\overline{\text{OE}}$ | Y | 2 V | | 30 | 120 | | 180 | | 150 | ns |
| | | | 4.5 V | | 15 | 24 | | 36 | | 30 | |
| | | | 6 V | | 14 | 20 | | 31 | | 26 | |
| t _t | | Any | 2 V | | 28 | 60 | | 90 | | 75 | ns |
| | | | 4.5 V | | 8 | 12 | | 18 | | 15 | |
| | | | 6 V | | 6 | 10 | | 15 | | 13 | |

SN54HC125, SN74HC125

QUADRUPLE BUS BUFFER GATES

WITH 3-STATE OUTPUTS

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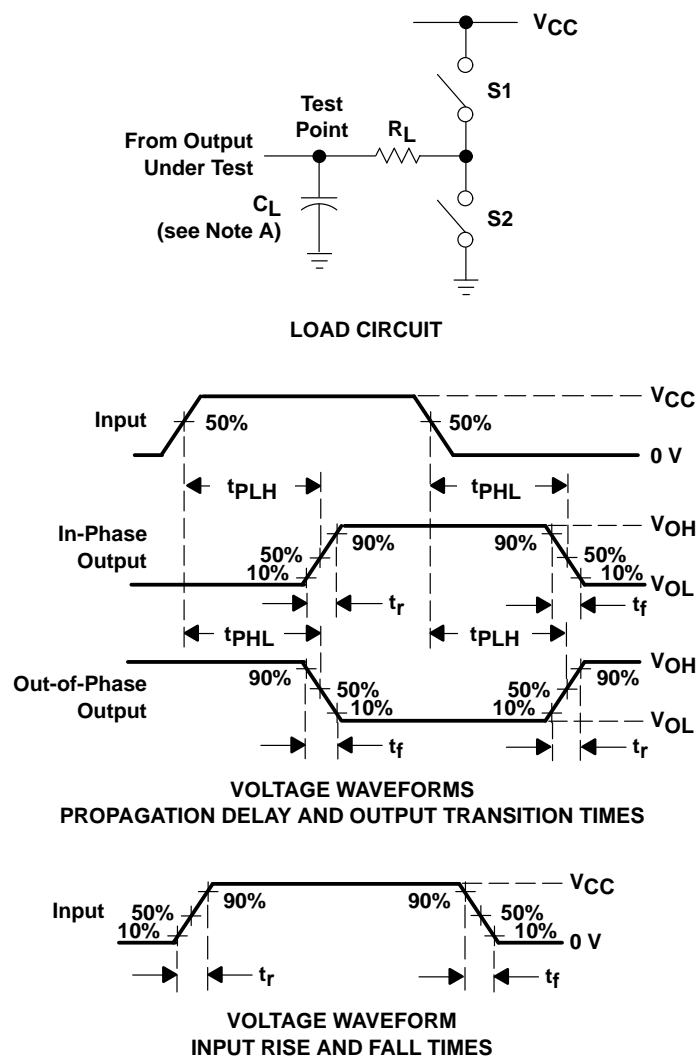
switching characteristics over recommended operating free-air temperature range, $C_L = 150 \text{ pF}$ (unless otherwise noted) (see Figure 1)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | V_{CC} | $T_A = 25^\circ\text{C}$ | | | SN54HC125 | | SN74HC125 | | UNIT |
|-----------|-----------------|----------------|----------|--------------------------|-----|-----|-----------|-----|-----------|-----|------|
| | | | | MIN | TYP | MAX | MIN | MAX | MIN | MAX | |
| t_{pd} | A | Y | 2 V | | 67 | 150 | | 225 | | 190 | ns |
| | | | 4.5 V | | 19 | 30 | | 45 | | 38 | |
| | | | 6 V | | 15 | 25 | | 39 | | 32 | |
| t_{en} | \overline{OE} | Y | 2 V | | 100 | 135 | | 200 | | 170 | ns |
| | | | 4.5 V | | 20 | 27 | | 40 | | 34 | |
| | | | 6 V | | 17 | 23 | | 34 | | 29 | |
| t_t | | Any | 2 V | | 45 | 210 | | 315 | | 265 | ns |
| | | | 4.5 V | | 17 | 42 | | 63 | | 53 | |
| | | | 6 V | | 13 | 36 | | 53 | | 45 | |

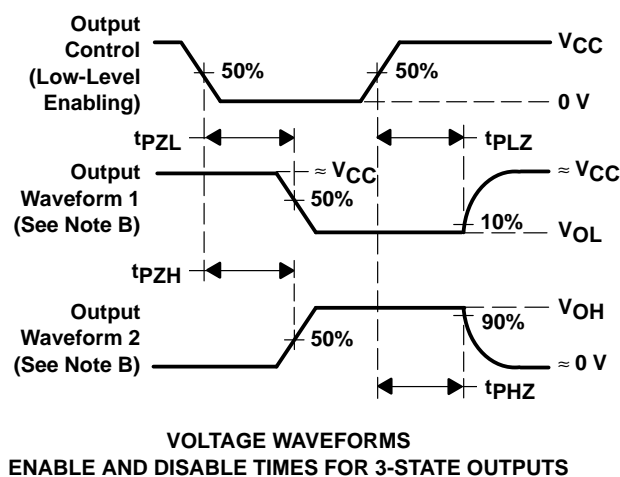
operating characteristics, $T_A = 25^\circ\text{C}$

| PARAMETER | | TEST CONDITIONS | TYP | UNIT |
|-----------|--|-----------------|-----|------|
| C_{pd} | Power dissipation capacitance per gate | No load | 45 | pF |

PARAMETER MEASUREMENT INFORMATION



| PARAMETER | R_L | C_L | S1 | S2 |
|-------------------|--------------|-----------------|--------|--------|
| t_{en} | 1 k Ω | 50 pF or 150 pF | Open | Closed |
| | | | Closed | Open |
| t_{dis} | 1 k Ω | 50 pF | Open | Closed |
| | | | Closed | Open |
| t_{pd} or t_t | — | 50 pF or 150 pF | Open | Open |



- NOTES:
- A. C_L includes probe and test-fixture capacitance.
 - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 - C. Phase relationships between waveforms were chosen arbitrarily. All input pulses are supplied by generators having the following characteristics: $PRR \leq 1$ MHz, $Z_O = 50 \Omega$, $t_r = 6$ ns, $t_f = 6$ ns.
 - D. The outputs are measured one at a time with one input transition per measurement.
 - E. t_{PLZ} and t_{PHZ} are the same as t_{dis} .
 - F. t_{PZL} and t_{PZH} are the same as t_{en} .
 - G. t_{PLH} and t_{PHL} are the same as t_{pd} .

Figure 1. Load Circuit and Voltage Waveforms

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